



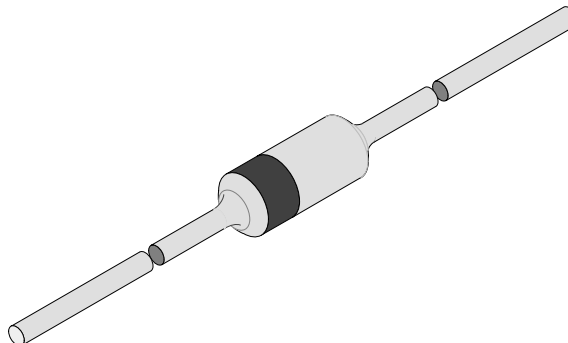
Switching Diode

Features

- Silicon Planar Diodes
- Very low reverse current

Applications

Protection circuits, time delay circuits,
peak follower circuits, logarithmic amplifiers



94 9367

Order Instruction

Type	Type Differentiation	Ordering Code	Remarks
BAS33	$V_{RRM} = 40\text{ V}$	BAS33-TAP	Tape and Reel
BAS34	$V_{RRM} = 70\text{ V}$	BAS34-TAP	Tape and Reel

Absolute Maximum Ratings

$T_j = 25^\circ\text{C}$

Parameter	Test Conditions	Type	Symbol	Value	Unit
Reverse voltage		BAS33	V_R	30	V
		BAS34	V_R	60	V
Peak forward surge current	$t_p = 1\mu\text{s}$		I_{FSM}	2	A
Forward current			I_F	200	mA
Junction temperature			T_j	200	$^\circ\text{C}$
Storage temperature range			T_{stg}	-65...+200	$^\circ\text{C}$

Maximum Thermal Resistance

$T_j = 25^\circ\text{C}$

Parameter	Test Conditions	Symbol	Value	Unit
Junction ambient	$l = 4\text{ mm}$, $T_L = \text{constant}$	R_{thJA}	350	K/W

Electrical Characteristics

$T_j = 25^\circ\text{C}$

Parameter	Test Conditions	Type	Symbol	Min	Typ	Max	Unit
Forward voltage	$I_F=100\text{mA}$		V_F			1	V
Reverse current	$E \leq 300\text{lX}, V_R$		I_R		1	3	nA
	$E \leq 300\text{lX}, V_R, T_j=125^\circ\text{C}$		I_R			0.5	μA
	$E \leq 300\text{lX}, V_R=15\text{V}$	BAS33	I_R		0.5	1	nA
	$E \leq 300\text{lX}, V_R=30\text{V}$	BAS34	I_R		0.5	1	nA
Breakdown voltage	$I_R=5\mu\text{A}, t_p/T=0.01, t_p=0.3\text{ms}$	BAS33	$V_{(BR)}$	40			V
	$I_R=5\mu\text{A}, t_p/T=0.01, t_p=0.3\text{ms}$	BAS34	$V_{(BR)}$	70			V
Diode capacitance	$V_R=0, f=1\text{MHz}$		C_D			3	pF

Characteristics ($T_j = 25^\circ\text{C}$ unless otherwise specified)

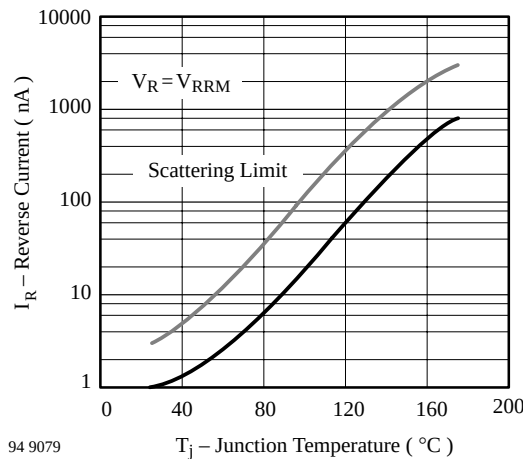


Figure 1. Reverse Current vs. Junction Temperature

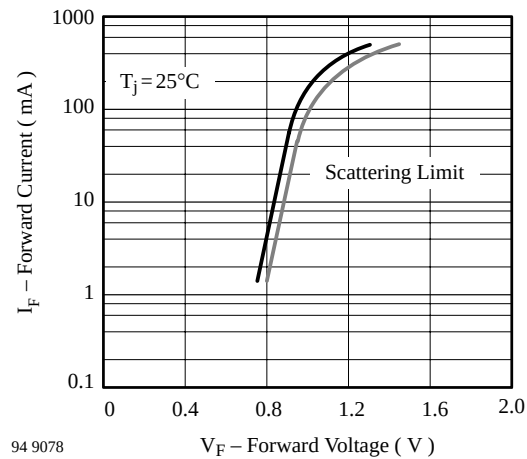
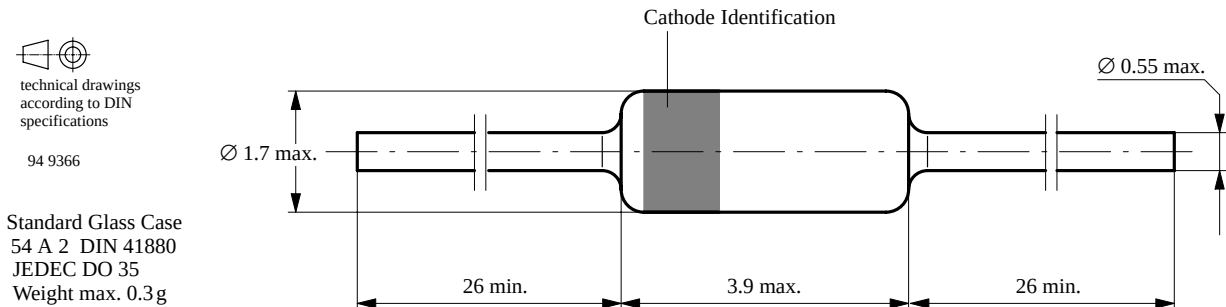


Figure 2. Forward Current vs. Forward Voltage

Dimensions in mm





Ozone Depleting Substances Policy Statement

It is the policy of **Vishay Semiconductor GmbH** to

1. Meet all present and future national and international statutory requirements.
2. Regularly and continuously improve the performance of our products, processes, distribution and operating systems with respect to their impact on the health and safety of our employees and the public, as well as their impact on the environment.

It is particular concern to control or eliminate releases of those substances into the atmosphere which are known as ozone depleting substances (ODSs).

The Montreal Protocol (1987) and its London Amendments (1990) intend to severely restrict the use of ODSs and forbid their use within the next ten years. Various national and international initiatives are pressing for an earlier ban on these substances.

Vishay Semiconductor GmbH has been able to use its policy of continuous improvements to eliminate the use of ODSs listed in the following documents.

1. Annex A, B and list of transitional substances of the Montreal Protocol and the London Amendments respectively
2. Class I and II ozone depleting substances in the Clean Air Act Amendments of 1990 by the Environmental Protection Agency (EPA) in the USA
3. Council Decision 88/540/EEC and 91/690/EEC Annex A, B and C (transitional substances) respectively.

Vishay Semiconductor GmbH can certify that our semiconductors are not manufactured with ozone depleting substances and do not contain such substances.

We reserve the right to make changes to improve technical design and may do so without further notice.

Parameters can vary in different applications. All operating parameters must be validated for each customer application by the customer. Should the buyer use VishaySemiconductors products for any unintended or unauthorized application, the buyer shall indemnify Vishay-Semiconductors against all claims, costs, damages, and expenses, arising out of, directly or indirectly, any claim of personal damage, injury or death associated with such unintended or unauthorized use.

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